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## **Claims**

Silicon nitride materials containing sintering aids and  $SiO_2$ , characterized in that the molar ratio of the silicon dioxide in the grain boundary phase to the sintering additives including  $SiO_2$  in the grain boundary phase is >60% and the oxide nitride content <1%.

- 2. Process for producing silicon nitride materials according to Claim 1, characterized in that, either alone or in combination,
  - a) the Si<sub>3</sub>N<sub>4</sub> powder used, either alone or together with the sintering aids, is thermally oxidized,
  - b) the Si<sub>3</sub>N<sub>4</sub> powder, either alone or together with the sintering aids and, if desired, further additives, is tribooxidized during milling and/or
  - the Si<sub>3</sub>N<sub>4</sub> powder is admixed with sintering aids or with SiO<sub>2</sub> or at least one SiO<sub>2</sub>-forming component either before or during milling.
- 20 3. Use of the silicon/nitride materials according to Claim 1 in the construction of machinery and apparatus, in particular in bearings.